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## M32C/81,82,83 Group

### Clock synchronous serial communication by using Intelligent I/O group 0,1 external clock

#### 1. Abstract

This application note describes the procedures of clock synchronous serial communication by using Intelligent I/O group 0,1 external clock.

#### 2. Introduction

This application note is applied to the M32C/83 group microcomputer.

This program can also be used when operating other microcomputers within M16C family, provided they have the same SFR (Special Function Registers) as the M32C/83 group. However, some functions may have been modified. Refer to the User's Manual for details. Use functions covered in this Application Note only after careful evaluation.

#### 3. Detailed description

This application example offers the features of the clock asynchronous serial communication by using M32C/83 group Intelligent I/O group 1 shown in Table 1.

The transmit data is output from the pin ISTxD1. The transfer clock is input from the pin ISCLK1, and the receive data is input from the pin ISRxD1.

Execute the operation to initialize the Intelligent I/O group 1 if the external clock stops during the communication.

Table 1 Clock synchronous serial I/O option features and selected features

Item	Definition	Selection
Transfer clock	Internal clock	
	External clock	Yes
Transfer format	LSB First	Yes
	MSB First	
TxD,RxD output polarity select	Not reverse	Yes
	Reverse	
Transfer interrupt factor	When G1TB register becomes empty	
	When the transmission is completed	Yes

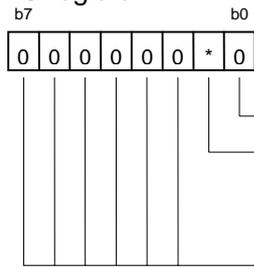
(Note) The communication setting must be operated when the port ISCLK1 is in "H".

## 3.1 Register setting

### 3.1.1 The procedures of the port setting

This section describes how to set the port to use for Intelligent I/O group 1. Refer to the M32C/83 group Hardware Manual for the details of each register.

#### (1) IPS register



- Don't use. Set the bits to 0.  
 Group 1 input port select bit  
 0 : assigns ISRxD1 to Port P7<sub>5</sub>  
 1 : assigns ISRxD1 to Port P11<sub>2</sub>

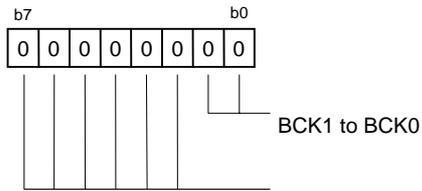
- Don't use. Set the bits to 000000<sub>2</sub>

This setting enables use of the receive pin.

#### (2) PSC register, PSLa register (a=0 to 3), PSb register (b=0 to 3, 5 to 9)



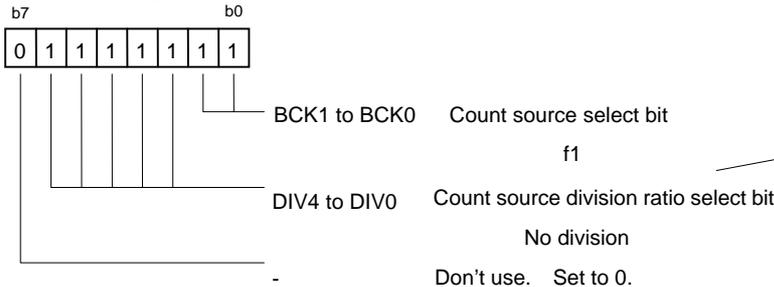
(5) G2BCR0 register



Count source select bit  
No clock  
Don't use. Set to 000000<sub>2</sub>.

If group 2 and register BTRSR are not used, disable supplying a clock to group 2.

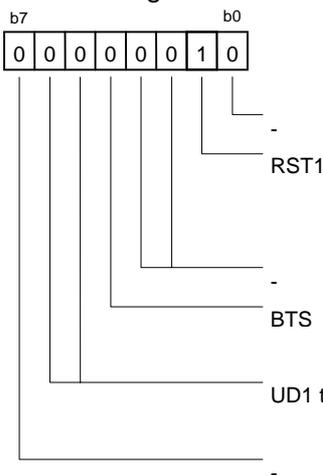
(6) G1BCR0 register



Count source select bit  
f1  
Count source division ratio select bit  
No division  
Don't use. Set to 0.

This setting enables supplying a clock to registers that are defined in step (7) thru (13). Set this register to 01111111<sub>2</sub> before going to the following steps.

(7) G1BCR1 register

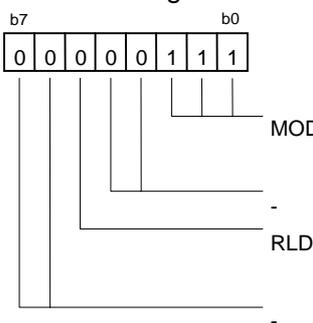


Don't use. Set to 0.  
Base timer reset cause select bit 1  
Reset base timer when the base timer content matches to the content of register G1PO0  
Don't use. Set to 00<sub>2</sub>.  
Base timer start bit  
Reset base timer  
Up-down control bit  
Up-count mode  
Don't use. Set to 0.

This register is used for generating the transfer clock. Set the bit RTS1 to 1 (The base timer is reset when the base timer content matches to the content of register G1PO0).

After setting the group 1 intelligent I/O relating register, set the BTS bit to "1" (base timer count start)

(8) G1POCR0 register

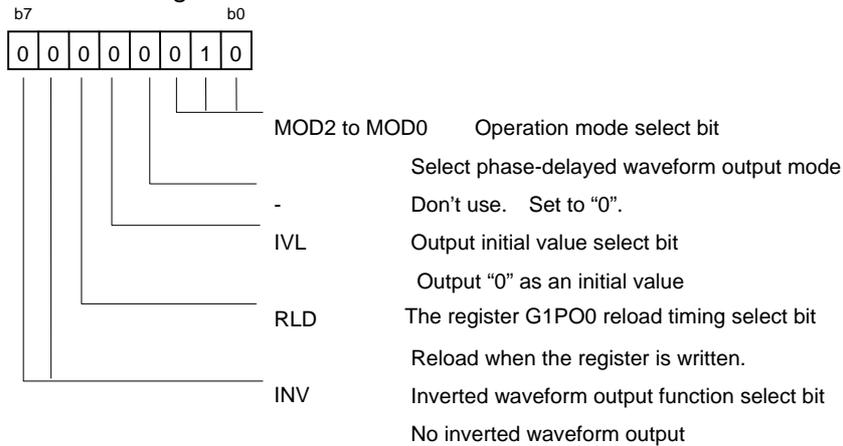


Operation mode select bit  
Select the output of the communication function  
Don't use. Set to 00<sub>2</sub>.  
The register G1PO0 reload timing select bit  
Reload when the register is written.  
Don't use. Set to "0".

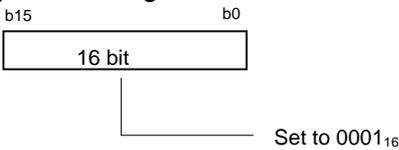
This setting selects pin ISTxD1 to transmit data.

The setting configures the reload action occurs at the same time data is written to register G1PO0

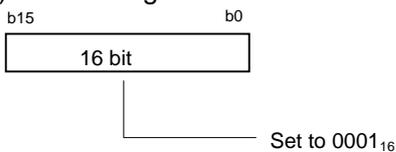
(9) G1POCR3 register



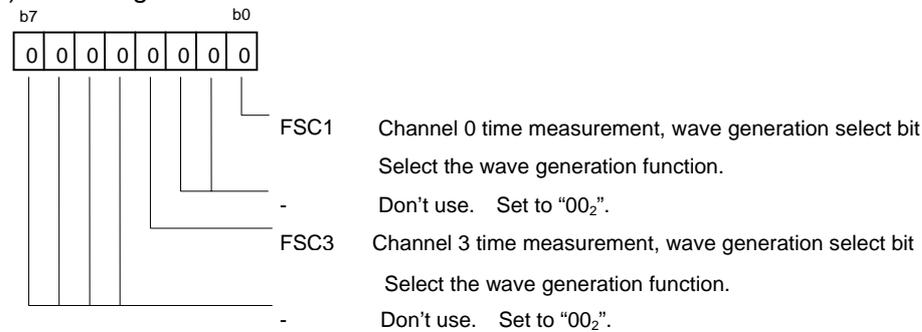
(10) G1PO0 register



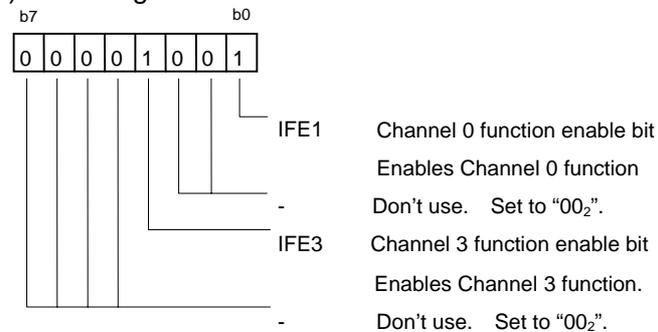
(11) G1PO3 register



(12) G1FS register

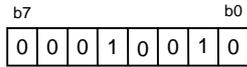


(13) G1FE register



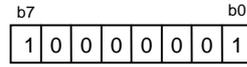
Set the bit IFE of un-used Channels to 0.

(14) G1BCR1 register



BTS Base timer start bit  
Enables base timer to start counting

(15) G1MR register



GMD1 to 0 Communication mode select bit  
Selects clock synchronous serial I/O mode

CKDIR Internal/External clock select bit  
Selects internal clock

- Don't use. Set to "000<sub>2</sub>".

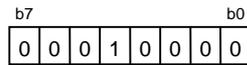
UFORM Transfer format select bit  
LSB first

IRS Transmit interrupt cause select bit  
Completes transmit (TXEPT=1)

Select a clock synchronous serial mode.

Select an internal clock.

(16) G1CR register



- Don't use. Set to "0000<sub>2</sub>".

TF Transmit enable bit  
Enables the transmit

RF Receive enable bit  
Disables the receive

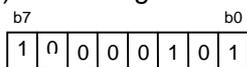
- Don't use. Set to "00<sub>2</sub>".

This setting enables the transmit to initialize the transmit buffer.

(17) Wait until the bit TXEPT = "1" (Transmit completes) in the register G1CR.

Outputs all data left in the transmit buffer by using the internal clock. (Initialization of the transmit buffer.)

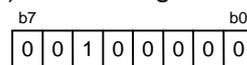
(18) G1MR register



CKDIR Internal / external clock select bit  
Selects external clock

Select the external clock

(19) G1ERC register



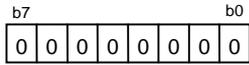
- Don't use. Set to "00000<sub>2</sub>".

RSHTE Receive shift operation enable bit  
Enables receive shift operation

- Don't use. Set to "00<sub>2</sub>".



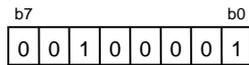
(25) IIO2IR register



Don't use. Set to "0".  
Initializes the interrupt request register.

The register must be set to 00<sub>16</sub>.  
If the register holds a value other than 00<sub>16</sub>, the bit IR in the register IIO3IC will not be set to "1" when an interrupt request is generated.

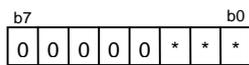
(26) IIO2IE register



IRLT Interrupt request select bit  
Uses interrupt request for an interrupt  
Don't use. Set to "0000<sub>2</sub>".  
SIOiRE Transmit interrupt of intelligent I/O group 1  
Enables the interrupt request.  
Don't use. Set to "00<sub>2</sub>".

Set the interrupt request bit not used for the interrupt to "0"

(27) IIO2IC register

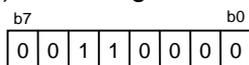


ILVL2 to ILVL0 Interrupt priority level select bit  
Selects the interrupt priority level.  
IR Interrupt request bit  
No Interrupt requested  
Don't use. Set to "0000<sub>2</sub>".

(28) Interrupt enabled (I flag = "1")

When using the interrupt, set I flag to "1" before setting the register for enabling receive and transmit operation.

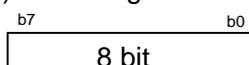
(29) G1CR register



Don't use. Set to "0000<sub>2</sub>".  
TE Transmit enable bit  
Enables the transmission  
RE Receive enable bit  
Enables the reception  
Don't use. Set to "00<sub>2</sub>".

This register enables the transmit and receive operation after the communication related register is set.

(30) G1TB register

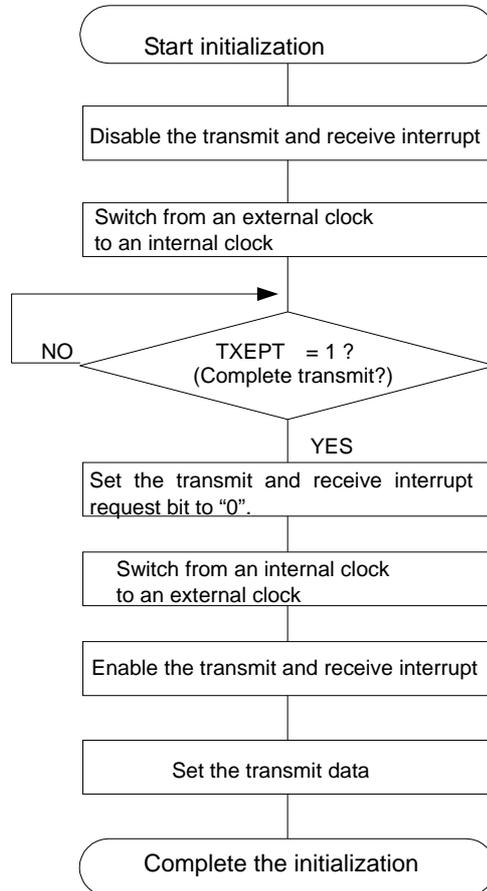


Transmit data

The write -action to the register starts the transmission.

### 3.2 Process of an initialization when an external clock stops during the communication

Data is remained in the transmit buffer when an external clock stops during the communication. Switch from an external clock to an internal clock to output all the data remained in the transmit data. (Initialization of the transmit buffer). The receive buffer does not have to be initialized because the data is overwritten on the next data.



### 3.3 Precaution on Interrupts

Set the register IIOiR (i=0 to 11) to "00<sub>16</sub>" (Initialization) during the intelligent I/O interrupt routine. If you skip this procedure, the IR bit in the IIOiC register is not set to "1" when the intelligent I/O generates the interrupt request, resulting in no interrupt being invoked.

#### 4. The example of a reference program

The following will show the example of a reference program to use intelligent I/O external clock for a clock synchronous serial communication. Some changes and arrangements of the program will be necessary according to each user's application.

```

/*****/
/*      File Name: rej05b0262_src.c          */
/*      Ver   : 1.00                        */
/*      FUNCTION:Clock synchronous serial   */
/*      communication by using intelligent I/O group external clock      */
/*****/
/*****/
/*      include fil          */
/*****/
#include <stdio.h>
#include "sfr32c83.h"

/*****/
/*      Function Definition */
/*****/
void iio_init(void);
void receive_int(void);
void trans_int(void);
#pragma INTERRUPT receive_int
#pragma INTERRUPT trans_int
/*****/
/*      Global Variable Definition      */
/*****/
static int rec_buff;

/*****/
/*      main Function          */
/*****/
void main(void){
    _asm(" fclr  i");      /* Disable the interrupt */

    /* main clock set      */
    prc0 = 1;              /* protect off */
    mcd = 0x12;           /* main clock : no division */
    prc0 = 0;            /* protect on */

    /* port set */
    ips = 0x00;          /* Set P75 as ISRxD1 */
    psc = 0x08;
    psl1 = 0x00;
    ps1 = 0x08;

    iio_init();          /* IIO synchronous communication initial set */

    g1tb = 0xD5;        /* Write the transmit the data */

    pd2 = 0xff;

```

```

pd4 = 0xff;
pd5 = 0xff;
while(1){
    /* external clock stop? */
    if( 0/* Check external clock stop */){
        iio_init();          /* IIO synchronous communication re-set */
        g1tb = 0x8a;        /* Set the receive data */
    }
}

/* iio communication function initialize */
void iio_init(void){
    short dummy;
    g1cr = 0x00;           /* Disable the transmit and receive operation */
    asm(" fclr i ");      /* Disable the interrupt request */
    /* base clock initial set */
    g2bcr0 = 0x7f;        /* Supply a clock for B TSR register */
    btsr = 0x00;          /* Base timer reset */
    g2bcr0 = 0x00;        /* Stop group 2 clock */

    /* iio group1 initial set */
    g1bcr0 = 0x7f;        /* b0,b1: count source f1
                           b2 to b6: division rate of count source: no division*/
    g1bcr1 = 0x02;
    g1pocr0 = 0x07;       /* ISTxD1 select */
    g1pocr3 = 0x02;
    g1po0 = 0x01;
    g1po3 = 0x00;

    g1fs = 0x00;          /* ch0,ch3 Select a waveform generation function */
    g1fe = 0x09;          /* ch0,ch3 Enable the operation */

    g1bcr1 = 0x12;        /* Start the base timer */

    g1mr = 0x81;          /* Internal clock */
    g1cr = 0x10;          /* Enable the transmit */

    /* wait */
    while(txempt_g1cr == 0)p1_5 = to p1_5; /* Output all the data remained in the transmit buffer by using the
                                           internal clock */
}

```

```

dummy = g1rb;
g1mr = 0x85;           /* clock synchronous serial, external clock, LSB first */
g1erc = 0x20;

/* iio group0 interrupt initial set */
iio2ie = 0x01;        /* Use the request use for interrupt */
iio3ie = 0x01;
iio2ir = 0x00;
iio3ir = 0x00;
iio2ie = 0x21;        /* gr1 Enable the receive interrupt */
iio3ie = 0x21;        /* gr1 Enable the transmit interrupt */
iio2ic = 0x03;        /* Select the interrupt priority level */
iio3ic = 0x03;        /* Select the interrupt priority level */

/* interrupt enable */
_asm("fset i");

/* sio initial setting */
g1cr = 0x30;          /* Enable the transmit and receive operation */

}

/* iio ch0 interrupt */
void receive_int(void){
    iio2ir = 0x00;      /* Clear the interrupt request */
    rec_buff = g1rb;    /* Read the received data */
    g1tb = 0x55;        /* Write the transmit data */
}

void trans_int(void){
    iio3ir = 0x00;      /* Clear the interrupt request */
}

/*----- end program */

```

## 5. Reference

HADWARE MANUAL

Refer to the M32C/83 group HARDWARE MANUAL.

## 6. Web-site and contact for support

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## REVISION HISTORY

Rev.	Issue date	Revised	
		Page	Point
1.00	Jan.30, 2004	-	First edition issued
1.01	Sep.16,2004	5	Inverted waveform output mode → phase-delayed waveform mode

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